

In-situ Monitoring in AM:

Challenges and Opportunities to Unlock Real-time Qualification

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Data & Manufacturing



Politecnico di Milano (since 1863) Largest technical university in Italy

Manufacturing and Mech Eng (2025)

- 1st in Italy
- 4th in Europe
- 12th worldwide

Engineering & Technology (2025)

- 1st in Italy
- 7th in Europe
- 21th worldwide



Visiting professor (spring 2024) – MechE - MIT Professor – Mech. Eng - Polimi PostPhD – Penn State

Senior Editor- Department Editor:

- Progress in Additive Manufacturing
- Additive Manufacturing Letters
- Informs Journal of Data Science
- IISE Transactions
- Journal of Quality Techology

Recent Awards:

- Royal Swedish Academy of Engineering Sciences 2023
- 2023 ENBIS Box Medal Award
- among the top 100 Italian woman scientists in STEM

Co-founder of the AddMe Lab, and 3D cell Lab IC Labs

Bio/2

Labs





PBF

- Aconity Midi+
 - multi-material
 - high preheating
- Renishaw AM2503D-NT LPBF system
 - Arcam A2

Binder-based AM

- Metal EXtrusion
- Shop System
- ExOne Innovent









•LPBF prototypes





DED

- Laser-DED
- WAAM



2PP

BIOPRINTING



AddMeLab



Extrusion





Digital light processing



Bio/3

Projects on insitu monitoring for AM



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In-situ Monitoring in AM:

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Opportunities

Why?

In-situ monitoring landscape

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AM: Complexity «for free»

Traditional manufacturing







Additive manufacturing



Complexity vs inspectability

«The limited stability and repeatability of the process still represent a major barrier for the industrial breakthrough of metal AM systems»

(Mani et al., 2015; Tapia and Elwany, 2014; Everton et al., 2016; Spears and Gold, 2016)

Why?

PROCESS

CONTROLLABLE Laser velocity Laser Power Laser Beam Diameter Layer thickness Inert Gas Flow Rate Inert Gas Flow Pattern Scanning Pattern

PREDEFINED

Powder Size Layer thickness Packing Density Absorptivity Reflectance Build Plate

Source: NIST -NISTIR 8036

«Process mapping»

PRODUCT

GEOMETRIC Dimensional deviations Geometric deviations

MECHANICAL Strength

Hardness Thoughness Fatigue Resistance

PHYSICAL

Residual Stresses Surface Roughness Porosity

AM: costs, times, sectors



- Anomaly detection (waste and time savings)
- Increase process understanding and support process optimization
- Supporting "unmanned AM"

Why not?

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In-situ monitoring in AM: why?

01/11/24



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In-situ monitoring for qualification





DETECTION/ACTION

Geometrical and dimensional errors



Volumetric errors



From monitoring to control



Effectiveness

It should be worth

Realistic conditions/case studies

Controlled false positive and false negative rates

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Effectiveness of insitu monitoring in real industrial settings





Thrust chamber of M10 liquid rocket engine for VEGA-E launch system Material: In718

Phase 1: structural integrity

Material: AlSi10Mg



Define maximum allowed defect sizes for a • highly loaded, mission critical part through fracture mechanical methods

Phase 2: in-situ monitoring



Develop an enhanced insitu process monitoring method (PMMs) to detect the critical defects size

Defect catalogue

Atlas of the defects

Root cause analysis

In-situ sensing

 Defect class
 Defect subclass

 Phase1
 Macro-geometrical (dimensional and geometrical)
 shrinkage, oversizing, super-elevated edges, warping, geometrical/dimensional deviations from nominal

 Micro-geometrical (Surface)
 roughness, balling, stair-stepping, dross formation, sagging, partial powder melting (sintering)

 Microstructure and inclusions
 microstructural inhomogeneity, contaminants inclusions, other material inclusions

 S
 Residual stress-induced
 thermal stresses, cracks, delamination

 Volumetric (porosity)
 lack-of-fusion, keyhole porosity, gas-induced porosity



Grasso & Colosimo, 2017, 2021

In-situ process monitoring method (PMM) selection

To identify the **most suitable PMMs**, a **scoring system** (1 to 5 – 5 being the most mature solution for anomaly detection) was developed considering:

- Maturity of the sensing solutions
- Defect detection probability (based on literature, industrial practice)
- Techno-economical gains
- Applicability to the IAMSPACE objective (phase 1)

| | LEVEL | PROCESS MONITORING METHOD | PROCESS SIGNATURES | SENSING METHODS | COMPATIBILITY WITH PROCESS CONTROL | MATURITY | RELATED DEFECTS | PROBABILITY OF DETECTING A DEFECT | TECHNO- ECONOMICAL GAINS | APPLICABILITY TO CASE STUDY | SCORE | Selected PMM | COMMENTS | Part I | |
|-----|-------|---|------------------------|--|--|--|---|--|--------------------------------|--------------------------------|-------|-----------------|--|--------|--|
| 4 | | <u>Powder bed</u> <u>inhomogeneity</u> | Powder bed image | Off-axis imaging in visible range | High - layerwise imaging - recoating errors deposition is detected. | 5 High (implemented in most 5 industrial systems) | Dimensional and geometrical defects Surface defects Porosity | High - but affected by 5 lighting conditions | Medium-High 4 | High 5 | 4,8 | YES | Selected because of highest score | | |
| 1 | 1 | <u>Printed</u> slice <u>geometry</u> | Printed slice image | Off-axis imaging in visible range | High - layerwise imaging - Possibility to reject defective parts or to stop their manufacturing if the process gets out of control | 5 Low (not implemented in industrial system, but with high potential) | Dimensional and geometrical defects | High - but affected by lighting conditions/Shrinkage and thermal-induced 5 distortion may not be captured on a layer-by- layer basis | High 5 | High S | 4,2 | YES | Selected because of high score, same equipment of Powder bed inhomogeneity and high potential in commercial systems | | |
| | 2 | <u>Slice dynamic</u> <u>siqnature</u> | Slice thermal map | Off-axis NIR/IR video imaging (EOS Optical Tomography) | Low - long time exposure image - Possibility to mark outlying behaviors of the printed parts during the process | Medium-Low (implemented 1 only in one 2 industrial system) | Dimensional and geometrical defects (linked to the presence of hot spots) | Low - high variability of thermal map intensities may mask actual anomalies | High 5 | Medium - Low 2 | 2,2 | NO | | | |
| Sun | 3 | <u>Meit pool</u> <u>monitoring</u> | Size and shape | Co-axial video imaging in visible and NIR/IR range | Medium - High - Simple video structure - computational time compatible with fast process dynamics | 4 Low (not implemented in industrial system, but with high potential) | Surface defect (Dross, sagging, roughness) | Medium - the defect is indirectly correlated 3 with the signature | Medium 3 | High 5 | 3,2 | NO | | | |
| | | | Radiation intensity | Co-axial video imaging in the visible range/Co- axial pyrometry | Medium - High - Simple 1D- signal/Simple video structure - compatible with fast process dynamics thanks to simple | 4 Medium - Low 2 (Co-axial | Porosity | Low - the defect is indirectly correlated 1 with the signature | Medium 3 | Medium 3 | 2,6 | NO | | | |
| | | | | | | 4 pyrometry implemented in some industrial systems) 2 | Surface Defects (Dross, sagging, roughness) | Medium - the defect is indirectly correlated 3 with the signature | Medium 3 | High 5 | 3,4 | YES | Selected because of the high potential | | |

Geometrical deviation from the nominal shape:

- A shape-agnostic image analysis approach
- Deviation from the nominal shape and related uncertainty
- 3. Self-starting anomaly detection procedure developed



The approach is able to avoid false positive and false negative!

PPM for geometrical deviation

- Sensitivity
- Robustness
- Effectiveness



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Sensitivity to Defect size





Robustness

- 1. Machines:
 - EOS M 400,
 - Customized Prima Additive@POLIMI)
- 2. Sensor configuration
 - camera location
- 3. Materials (AlSi10Mg*)



*similar campaign on In718

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Defect

Camera setting and architecture – the existing solutions

Industrial AS-IS

Machine EOS M 400 Camera model iDS UI-5490SE Focal length 25 mm Working distance 600 mm Resolution Configuration

50 µm/px Off-axis (front viewport)

Industrial improved

Machine Camera model Focal length 8.5 mm Working distance Resolution Configuration

3DNT @Polimi iDS UI-5490SE 400 mm 80 µm/px Off-axis (top

viewport)

Machine Camera model Working distance Resolution Configuration

Novel

3DNT @Polimi Line scanner 15 mm 21 µm/px Blade-mounted







Scan it: The intelligent recoater

Size and sensing matter!

- High resolution (21 μm/px)
- Built-in illumination
- Color imaging (discoloration, oxidation can be observed)
- Line sensor (encoder is required for synchronization and 2D image reconstruction)

Contact image sensors (CIS) usually used in our printer scanner



Synchronous **line scanner** mounted on powder recoater for **powder bed topography** (5 μ m/pixel)

Non-uniformities in the powder bed are identified by quantifying out-of-focus regions in the raw scans



Effectiveness (Probability of Detection – POD)

We explored the Probability of defect detection to characterize our PMM solution as a function of the defect size.



Significant improvement in the POD can be achieved by improving the sensing solutions





Metamaterial or lattice structures

Colosimo and Grasso, JQT 2022 - ASQ Brumbaugh





Lattice – a regular grid of unit cells

Main applications (weight, vibration, cooling, cell integration)





AERO



RACING



MACHINERY



BIO

Examples of **defects** in lattice structures

(Liu et al., 2017; Melancon et al., 2017; Dallago et al., 2019)



Geometrical deviation via off-axis imaging

Lattice structure



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Colosimo and Grasso, JQT 2022 – ASQ Brumbaugh Award 23

Geometrical deviation via off-axis imaging

Lattice structure



profile



BSPLINE FUNCTIONAL DATA

MULTIVARAITE CONTROL CHARTING ON COEFFICIENTS (DIMENISONAL REDUCTION)

Geometrical deviation via off-axis imaging

Lattice structure

Example of layer with dark-field pattern



DARK-FIELD IMAGE (good reconstruction)



Example of layer with bright-field pattern



BRIGTH-FIELD IMAGE (bad reconstruction)

In-situ WBspline



Weighted bspline

 $P_j = (B^T W(z)B)^{-1} B^T W(z) \delta_j(z)$ $\omega(z) = \frac{1}{s_b(z)^2}$

Weight = inverse of the pixel intensity variance in a band around the detected edge

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Trustiness ... and a final question

Assess the real TRL of all the developed solutions

Hot-and cold- spot detection

Image: Sector of the sector of th

Colosimo& Grasso 2018; Yan et al. 2022; Bugatti & Colosimo 2022, Caltanissetta et al. 2022

osity [%] (log s

Surface texturing and Roughness prediction



Bugatti & Colosimo 2024



Repossini et al., 2017; Colosimo et al., 2024

Microstructure (classification amd prediction)





Colosimo & Grasso, 2025

Spattering

Data is not information and information is not knowledge



Fig. 7. Categories of different machine learning algorithms (all the abbreviations are listed in the nomenclature and can be found in the paper).

Digital+green = "twin" transition ?





Thank you for the attention

Contact

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